

# 2014 3rd International Conference on Applied Materials and Electronics Engineering (AMEE 2014)

April 26-27, 2014 Hong Kong

<http://www.iwamee.com/index.html>

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## Official Invited Letter

Dear Minghui Yang

We are pleased to invite you that to participate in the 2014 3rd International Conference on Applied Materials and Electronics Engineering (AMEE 2014).

### General Information

The 2014 2nd International Conference on Applied Materials and Electronics Engineering (AMEE 2013) will be held from April 26th, 2014 in HongKong. This conference is sponsored by International Association for Scientific and High Technology and International Science and Engineering Research Center, and it is technical co-sponsored by Trans Tech Publications and Academy Publisher. The conference will continue the excellent tradition of gathering world-class researchers and engineers engaged in the fields of Applied Materials and Electronics Engineering to meet and present their latest activities. You are cordially invited to attend this interesting event.

AMEE 2014, All accepted papers will be published in the Advanced Materials Research (ISSN:1022-6680). (Indexed by Elsevier: SCOPUS [www.scopus.com](http://www.scopus.com) and Ei Compendex (CPX) [www.ei.org/](http://www.ei.org/). Cambridge Scientific Abstracts (CSA) [www.csa.com](http://www.csa.com), Chemical Abstracts (CA) [www.cas.org](http://www.cas.org), Google and Google Scholar [google.com](http://google.com), ISI (ISTP, CPCI, Web of Science) [www.isinet.com](http://www.isinet.com), Institution of Electrical Engineers (IEE) [www.iee.org](http://www.iee.org), etc.)

The modified and extended excellence papers will be published by the special issues for the following Journals:

**International Journal of Materials and Product Technology (IJMPT, SCIE, SciSearch, Impact Factor: 0.258)**

**Materials Science (ISSN 2083-134X, SCIE, SciSearch, Impact Factor of 0.366 )**

We hope to see you in Hong Kong, China, April, 2014.



Yours faithfully,

AMEE 2014 Organization Committee

Jan.09, 2014